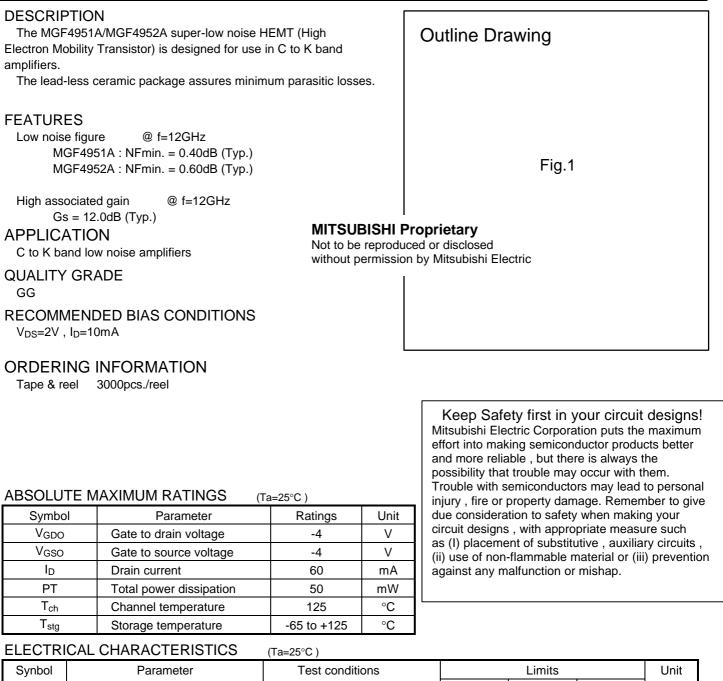
June/2004

MITSUBISHI SEMICONDUCTOR <GaAs FET> MGF4951A/MGF4952A

SUPER LOW NOISE InGaAs HEMT (Leadless Ceramic Package)



Synbol	Parameter	Test conditions			Unit		
				MIN.	TYP.	MAX	
V _{(BR)GDO}	Gate to drain breakdown voltage	I _G =-10μΑ		-3			V
I _{GSS}	Gate to source leakage current	V _{GS} =-2V,V _{DS} =0V				50	μA
I _{DSS}	Saturated drain current	V _{GS} =0V,V _{DS} =2V		15		60	mA
V _{GS(off)}	Gate to source cut-off voltage	$V_{DS}=2V,I_{D}=500\mu A$		-0.1		-1.5	V
gm	Transconductance	V _{DS} =2V,I _D =10mA			70		mS
Gs	Associated gain	V _{DS} =2V,		11.0	12.0		dB
NFmin.	Minimum noise figure	I _D =10mA	MGF4951A		0.40	0.50	dB
		f=12GHz	MGF4952A		0.60	0.80	dB

SUPER LOW NOISE InGaAs HEMT (Leadless Ceramic Package)

Fig.1

Unit : mm

1

0

BOTTOM

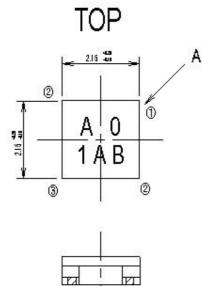
100,000

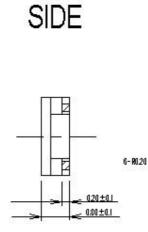
٢

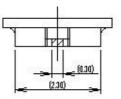
ANT ANT

Square shape electrode is Drain.

brass and







from "A" side view

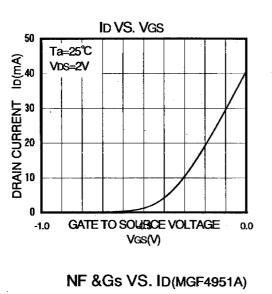
Gate
Source
Drain

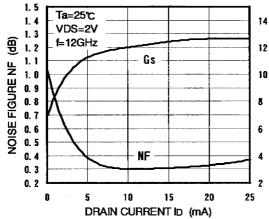
MITSUBISHI

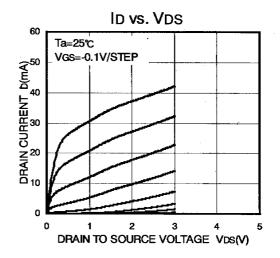
June/2004

SUPER LOW NOISE InGaAs HEMT (Leadless Ceramic Package)

TYPICAL CHARACTERISTICS (Ta=25°C)







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MITSUBISHI SEMICONDUCTOR <GaAs FET> MGF4951A/MGF4952A

SUPER LOW NOISE InGaAs HEMT (Leadless Ceramic Package)

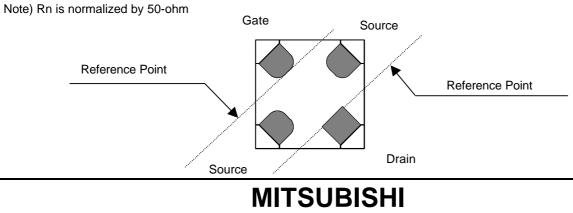
S PARAMETERS

(Ta=25°C,VDS=2V,ID=10mA)

f	S	11	S21		S12		S22	
(GHz)	Magn.	Angle	Magn.	Angle	Magn.	Angle	Magn.	Angle
1.0	0.978	-14.5	4.800	163.6	0.019	78.3	0.525	-13.5
2.0	0.930	-26.3	4.857	152.8	0.037	72.5	0.513	-22.5
3.0	0.884	-43.8	4.702	133.4	0.053	59.5	0.491	-37.6
4.0	0.818	-59.6	4.514	119.5	0.066	51.1	0.458	-47.5
5.0	0.768	-71.1	4.224	108.2	0.076	44.7	0.449	-54.6
6.0	0.722	-80.2	4.008	98.9	0.084	40.1	0.444	-58.7
7.0	0.681	-88.9	3.841	89.8	0.092	36.6	0.439	-61.2
8.0	0.652	-100.4	3.681	45.6	0.099	27.8	0.440	-68.2
9.0	0.627	-17.3	3.540	66.6	0.108	24.0	0.444	-70.2
10.0	0.593	-114.4	3.476	57.5	0.117	21.3	0.442	-72.3
11.0	0.542	-123.2	3.474	47.7	0.130	15.6	0.418	-76.0
12.0	0.475	-133.8	3.487	37.0	0.142	9.6	0.380	-78.3
13.0	0.406	-148.6	3.458	25.5	0.153	2.4	0.326	-82.4
14.0	0.333	-178.7	3.415	7.5	0.162	-11.0	0.234	-90.5
15.0	0.298	147.3	3.309	-5.6	0.172	-20.2	0.132	-83.7
16.0	0.338	110.1	3.150	-20.1	0.175	-30.0	0.068	-20.3
17.0	0.443	81.5	2.965	-34.2	0.176	-39.6	0.169	25.0
18.0	0.564	60.0	2.670	-48.8	0.171	-50.4	0.301	26.1
19.0	0.675	44.4	2.323	-62.6	0.159	-60.0	0.431	21.3
20.0	0.763	32.1	2.030	-74.2	0.146	-69.4	0.537	15.7
21.0	0.846	18.5	1.714	-90.8	0.133	-80.3	0.612	4.5
22.0	0.892	8.8	1.457	-101.1	0.119	-86.8	0.684	1.2
23.0	0.912	1.4	1.233	-109.9	0.104	-92.2	0.749	-2.5
24.0	0.927	-4.8	1.026	-118.4	0.093	-95.3	0.796	-5.5
25.0	0.932	-9.4	0.864	-124.7	0.080	-98.0	0.843	-7.1
26.0	0.933	-14.0	0.732	-130.2	0.069	-100.6	0.881	-8.6

NOISE PARAMETERS (Ta=25°C,VDS=2V,ID=10mA)

f	Gann	na-opt	Rn	NF
(GHz)	Magn.	Angle	(ohm)	(dB)
4.0	0.64	49.7	0.21	0.21
8.0	0.61	100.5	0.12	0.31
12.0	0.55	143.4	0.04	0.45
14.0	0.51	158.9	0.03	0.52
18.0	0.41	172.5	0.06	0.66



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